

- ( ) Preliminary Specifications(✓) Final Specifications

Module	17.3"(17.25") FHD 16:9 Color TFT-LCD with LED Backlight design
Model Name	B173HW01 V5 (H/W:0A)
Note (♠)	LED Backlight with driving circuit design

Customer	Date
Checked & Approved by	Date
Note: This Specification change without notice.	is subject to

Approved by	Date				
Howard fee	<u>02/12/2010</u>				
Prepared by	Date				
<u>Buffy Chen</u>	<u>02/12/2010</u>				
NBBU Marketing Division AU Optronics corporation					



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# **Record of Revision**

Vei	rsion and Date	Page	Old description	New Description	Remark
0.1	2009/09/28	All	First Edition for Customer		
1.0	2010/02/12	All	Final Specification.		



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### 1. Handling Precautions

- 1) Since front polarizer is easily damaged, pay attention not to scratch it.
- 2) Be sure to turn off power supply when inserting or disconnecting from input connector.
- 3) Wipe off water drop immediately. Long contact with water may cause discoloration or spots.
- 4) When the panel surface is soiled, wipe it with absorbent cotton or other soft cloth.
- 5) Since the panel is made of glass, it may break or crack if dropped or bumped on hard surface.
- 6) Since CMOS LSI is used in this module, take care of static electricity and insure human earth when handling.
- 7) Do not open nor modify the Module Assembly.
- 8) Do not press the reflector sheet at the back of the module to any directions.
- 9) At the insertion or removal of the Signal Interface Connector, be sure not to rotate nor tilt the Interface Connector of the TFT Module.
- 11) After installation of the TFT Module into an enclosure (Notebook PC Bezel, for example), do not twist nor bend the TFT Module even momentary. At designing the enclosure, it should be taken into consideration that no bending/twisting forces are applied to the TFT Module from outside. Otherwise the TFT Module may be damaged.
- 12) Small amount of materials having no flammability grade is used in the LCD module. The LCD module should be supplied by power complied with requirements of Limited Power Source (IEC60950 or UL1950), or be applied exemption.
- 13) Disconnecting power supply before handling LCD modules, it can prevent electric shock, DO NOT TOUCH the electrode parts, cables, connectors and LED circuit part of TFT module that a LED light bar build in as a light source of back light unit. It can prevent electrostic breakdown.



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### 2. General Description

B173HW01 V5 is a Color Active Matrix Liquid Crystal Display composed of a TFT LCD panel, a driver circuit, and LED backlight system. The screen format is intended to support the FHD 16:9 1920(H) x 1080(V) screen and 262k colors (RGB 6-bits data driver) with LED backlight driving circuit. All input signals are LVDS interface compatible.

B173HW01 V5 is designed for a display unit of notebook style personal computer and industrial machine.

## 2.1 General Specification

Items	Unit	Specifications				
Screen Diagonal	[mm]	17.3W"(17.2	17.3W"(17.25)			
Active Area	[mm]	381.888 X 214.812				
Pixels H x V		1920x3(RGB	) x1080			
Pixel Pitch	[mm]	0.1989X0.198	39			
Pixel Format		R.G.B. Vertic	cal Stripe			
Display Mode		Normally Wh	nite			
White Luminance (ILED=20mA) (Note: ILED is LED current)	[cd/m²]	, , , ,	ooints averag	,		
Luminance Uniformity		1.25 max. (5	points) / 1.35	5 max. (13 poir	nts)	
Contrast Ratio		400 typ				
Response Time	[ms]	8 typ / 16 Max				
Nominal Input Voltage VDD	[Volt]	+3.3 typ.				
Power Consumption	[Watt]	9.0 max. (Include Logic and Blu power)				
Weight	[Grams]	590 max.				
Physical Size			Min.	Тур.	Max.	
Include bracket	[mm]	Length	397.6	398.1	398.6	
	[mm]	Width	232.3	232.8	233.3	
		Thickness			6.0	
Electrical Interface		2 channel L'	VDS			
Glass Thickness	[mm]	0.5				
Surface Treatment		Anti-Glare Anti-Glare				
Support Color		262K colors ( RGB 6-bit )				
Temperature Range Operating Storage (Non-Operating)	[°C]	0 to +50 -20 to +60				
RoHS Compliance		RoHS Comp	liance			



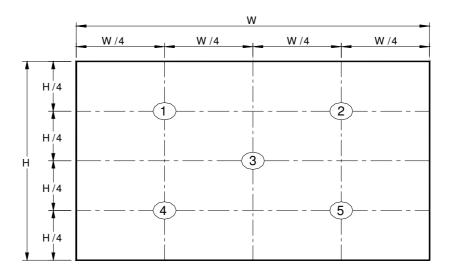
## 2.2 Optical Characteristics

The optical characteristics are measured under stable conditions at  $25^{\circ}$ C (Room Temperature):

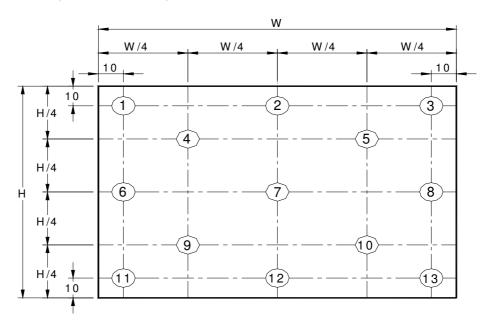
Item		Symbol	Conditions	Min.	Тур.	Max.	Unit	Note
White Luminance ILED=20mA			5 points average	270	300		cd/m²	1, 4, 5.
		θR	Horizontal (Right)	60	70			
Viewing Ar	nale	θι	CR = 10 (Left)	60	70		degre	4.0
VICWING / (I	igio	Ψн	Vertical (Upper)	45	60		е	4, 9
		ΨL	CR = 10 (Lower)	50	60			
Luminance Un	iformity	<b>δ</b> 5P	5 Points			1.25		1, 3, 4
Luminance Un	iformity	δ <sub>13P</sub>	13 Points			1.42		2, 3, 4
Contrast Ro	atio	CR		300	400			4, 6
Cross tal	k	%				4		4, 7
Response T	ime	T <sub>RT</sub>	Rising + Falling		8	16	msec	4, 8
Red		Rx		0.603	0.638	0.668		
	Red	Ry		0.301	0.331	0.361		
	Croon	Gx		0.272	0.302	0.332		
Color / Chromaticity				0.581	0.611	0.641		
Coodinates		Bx	CIE 1931	0.118	0.148	0.178		4
	Blue	Ву		0.027	0.057	0.087		
		Wx		0.283	0.313	0.343		
	White	Wy		0.299	0.329	0.359		
NTSC		%			72			



Note 1: 5 points position (Ref: Active area)



Note 2: 13 points position (Ref: Active area)



Note 3: The luminance uniformity of 5 or 13 points is defined by dividing the maximum luminance values by the minimum test point luminance

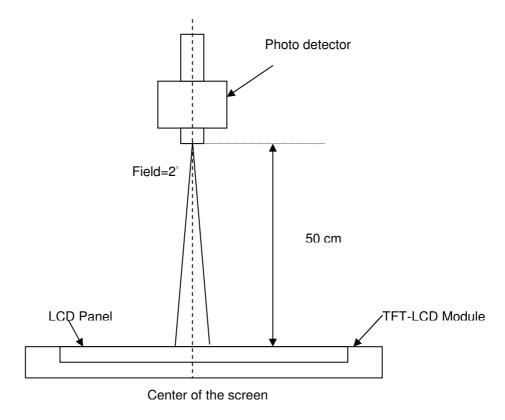
2	Maximum Brightness of five points
δ <sub>w5</sub> =	Minimum Brightness of five points
2	Maximum Brightness of thirteen points
$\delta_{W13} =$	Minimum Brightness of thirteen points

#### Note 4: Measurement method

The LCD module should be stabilized at given temperature for 30 minutes to avoid abrupt temperature change during measuring. In order to stabilize the luminance, the measurement should



be executed after lighting Backlight for 30 minutes in a stable, windless and dark room, and it should be measured in the center of screen.



**Note 5**: Definition of Average Luminance of White (Y<sub>L</sub>):

Measure the luminance of gray level 63 at 5 points,  $Y_L = [L(1) + L(2) + L(3) + L(4) + L(5)] / 5$ L (x) is corresponding to the luminance of the point X at Figure in Note (1).

Note 6: Definition of contrast ratio:

Contrast ratio is calculated with the following formula.

Brightness on the "White" state Contrast ratio (CR)= Brightness on the "Black" state

Note 7: Definition of Cross Talk (CT)

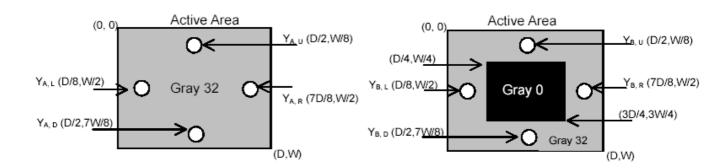
$$CT = | Y_B - Y_A | / Y_A \times 100 (\%)$$

#### Where

Y<sub>A</sub> = Luminance of measured location without gray level 0 pattern (cd/m<sub>2</sub>)

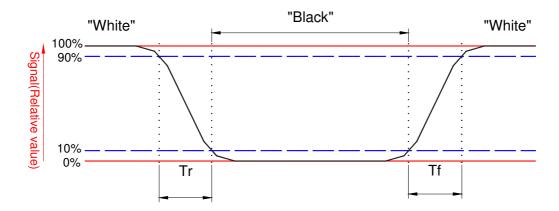
 $Y_B = Luminance$  of measured location with gray level 0 pattern (cd/m<sub>2</sub>)





Note 8: Definition of response time:

The output signals of BM-7 or equivalent are measured when the input signals are changed from "Black" to "White" (falling time) and from "White" to "Black" (rising time), respectively. The response time interval between the 10% and 90% of amplitudes. Refer to figure as below.

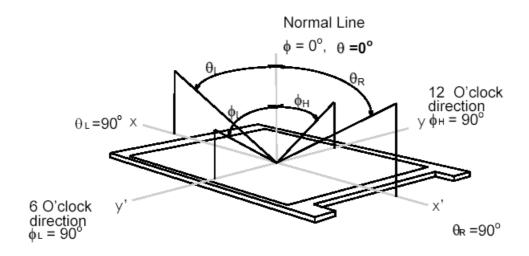




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### Note 9. Definition of viewing angle

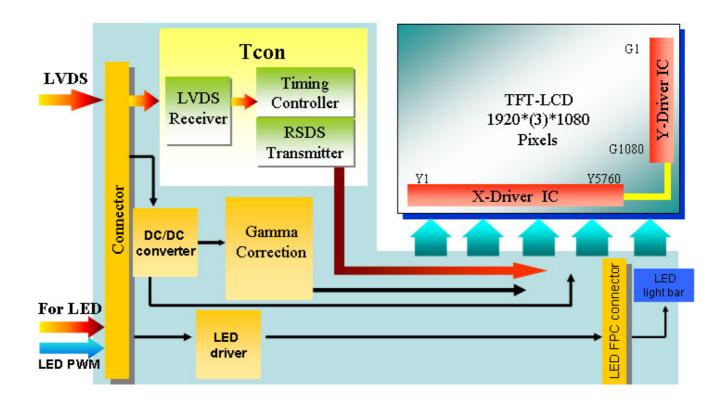
Viewing angle is the measurement of contrast ratio  $\geq$  10, at the screen center, over a 180° horizontal and 180° vertical range (off-normal viewing angles). The 180° viewing angle range is broken down as follows; 90° ( $\theta$ ) horizontal left and right and 90° ( $\Phi$ ) vertical, high (up) and low (down). The measurement direction is typically perpendicular to the display surface with the screen rotated about its center to develop the desired measurement viewing angle.





## 3. Functional Block Diagram

The following diagram shows the functional block of the 17.3 inches wide Color TFT/LCD 40 Pin one channel Module





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## 4. Absolute Maximum Ratings

An absolute maximum rating of the module is as following:

### 4.1 Absolute Ratings of TFT LCD Module

Item	Symbol	Min	Max	Unit	Conditions
Logic/LCD Drive	Vin	-0.3	+4.0	[Volt]	Note 1,2

4.2 Absolute Ratings of Environment

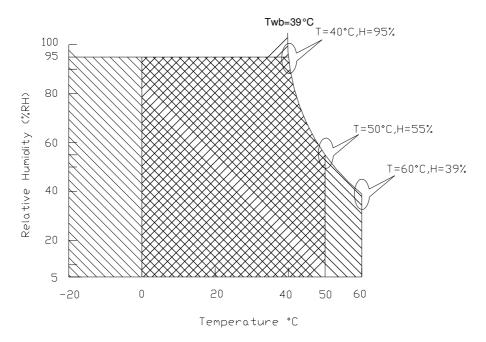
n= / no ociore mannigo or								
Item	Symbol	Min	Max	Unit	Conditions			
Operating	TOP	0	+50	[°C]	Note 4			
Operation Humidity	HOP	5	95	[%RH]	Note 4			
Storage Temperature	TST	-20	+60	[°C]	Note 4			
Storage Humidity	HST	5	95	[%RH]	Note 4			

Note 1: At Ta (25°€)

Note 2: Permanent damage to the device may occur if exceed maximum values

Note 3: LED specification refer to section 5.2

Note 4: For quality performance, please refer to AUO IIS (Incoming Inspection Standard).



Operating Range

Storage Range

+

## 5. Electrical Characteristics

#### 5.1 TFT LCD Module

#### **5.1.1 Power Specification**

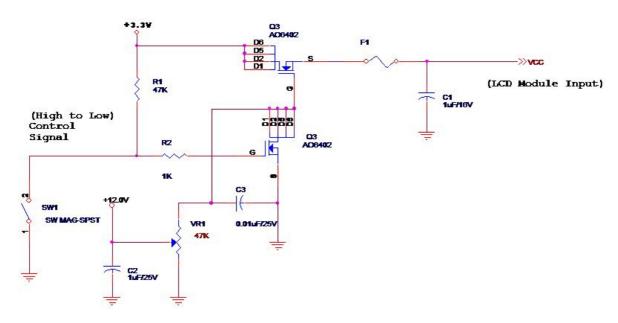
Input power specifications are as follows;

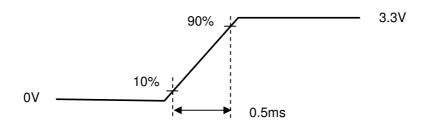
The power specification are measured under 25°C and frame frenquency under 60Hz

Symble	Parameter	Min	Тур	Max	Units	Note
VDD	Logic/LCD Drive Voltage	3.0	3.3	3.6	[Volt]	
PDD	VDD Power	-	-	2	[Watt]	Note 1
IDD	IDD Current	-	350	600	[mA]	Note 1
IRush	Inrush Current	-	-	2000	[mA]	Note 2
VDDrp	Allowable Logic/LCD Drive Ripple Voltage	-	-	100	[mV] p-p	

Note 1: Maximum Measurement Condition: Black Pattern at 3.3V driving voltage. (Pmax=V3.3 x lblack)

Note 2: Measure Condition





Vin rising time



### **5.1.2 Signal Electrical Characteristics**

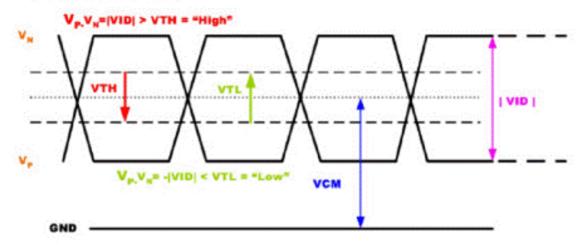
Input signals shall be low or High-impedance state when VDD is off.

Signal electrical characteristics are as follows;

Parameter	Condition	Min	Max	Unit
V <sub>th</sub>	Differential Input High Threshold (Vcm=+1.2V)		100	[mV]
VtI	Differential Input Low Threshold (Vcm=+1.2V)	-100		[mV]
V <sub>ID</sub>	Differential Input Voltage	100	600	[mV]
V <sub>cm</sub>	Differential Input Common Mode Voltage	1.125	1.375	[٧]

Note: LVDS Signal Waveform

## Single-end Signal





### 5.2.1 LED characteristics

Parameter	Symbol	Min	Тур	Max	Units	Condition
Backlight Power Consumption	PLED	-	-	7	[Watt]	(Ta=25°C), Note 1. Vin=12V
LED Life-Time	N/A	10,000	-	-	Hour	(Ta=25°C), Note 2 $I_F$ =20 mA

Note 1: Calculator value for reference PLED = VF (Normal Distribution) \* IF (Normal Distribution) / Efficiency

Note 2: The LED life-time define as the estimated time to 50% degradation of initial luminous.

## 5.2.2 Backlight input signal characteristics

Parameter	Symbol	Min	Тур	Max	Units	Remark
LED Power Supply	VLED	6.0	12.0	21.0	[Volt]	
LED Enable Input High Level	VIED EN	2.5	-	5.5	[Volt]	
LED Enable Input Low Level	VLED_EN	-	-	0.8	[Volt]	Define as
PWM Logic Input High Level		2.5	-	5.5	[Volt]	Connector Interface
PWM Logic Input Low Level	VPWM_EN	-	-	0.8	[Volt]	(Ta=25°C)
PWM Input Frequency	FPWM	100	200	20K	Hz	
PWM Duty Ratio	Duty	5		100	%	



## 6. Signal Interface Characteristic

## 6.1 Pixel Format Image

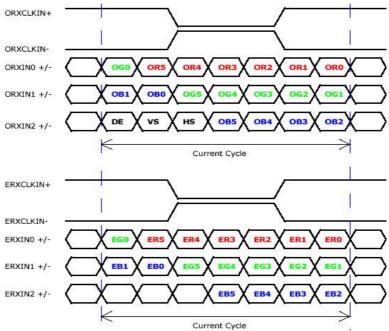
Following figure shows the relationship of the input signals and LCD pixel format.

		1			2			1	919	)	_1	920	
1 <sup>st</sup> Line	R	G	В	R	G	В	•••••	R	G	В	R	G	В
		:							:			:	
1000 J. T.L.													
1080th Line	R	G	В	R	G	В	•••••	R	G	В	R	G	В



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## 6.2 The Input Data Format



Signal Name	Description	
R5	Red Data 5 (MSB)	Red-pixel Data
R4	Red Data 4	Each red pixel's brightness data consists of these 6 bits pixel data.
R3	Red Data 3	
R2	Red Data 2	
R1	Red Data 1	
RO	Red Data 0 (LSB)	
	Red-pixel Data	
G5	Green Data 5 (MSB)	Green-pixel Data
G4	Green Data 4	Each green pixel's brightness data consists of these 6 bits pixel
G3	Green Data 3	data.
G2	Green Data 2	durd.
Gl	Green Data 1	
G0	Green Data 0 (LSB)	
	,	
	Green-pixel Data	
B5	Blue Data 5 (MSB)	Blue-pixel Data
B4	Blue Data 4	Each blue pixel's brightness data consists of these 6 bits pixel data.
В3	Blue Data 3	
B2	Blue Data 2	
B1	Blue Data 1	
ВО	Blue Data 0 (LSB)	
	Blue-pixel Data	
RxCLKIN	Data Clock	The signal is used to strobe the pixel data and DE signals. All pixel
IXCERT	Baia cieck	data shall be valid at the falling edge when the DE signal is high.
DE	Display Timing	This signal is strobed at the falling edge of
		RxCLKIN. When the signal is high, the pixel data shall be valid to
		be displayed.
VS	Vertical Sync	The signal is synchronized to RxCLKIN.
HS	Horizontal Sync	The signal is synchronized to RxCLKIN.

Note: Output signals from any system shall be low or High-impedance state when VDD is off.



## 6.3 Integration Interface Requirement

#### 6.3.1 Connector Description

Physical interface is described as for the connector on module.

These connectors are capable of accommodating the following signals and will be following components.

Connector Name / Designation	For Signal Connector
Manufacturer	IPEX or Compatible
Type / Part Number	IPEX 20455-040E-12R or Compatible
Mating Housing/Part Number	IPEX 20453-040T-11 or Compatible

### 6.3.2 Pin Assignment

LVDS is a differential signal technology for LCD interface and high speed data transfer device.

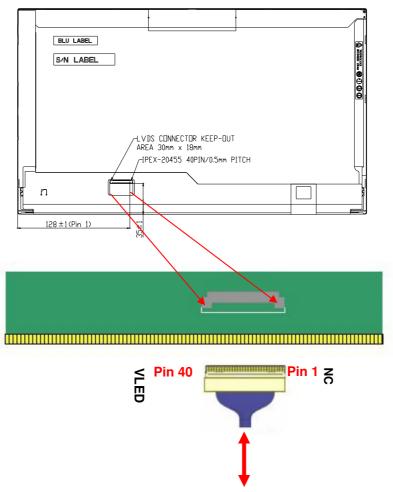
PIN#	Signal Name	Description
1	NC	No Connection
2	VDD	Power Supply +3.3V
3	VDD	Power Supply +3.3V
4	VEDID	EDID +3.3V Power
5	NC	No Connect (Reserve for M1 aging)
6	CLKEDID	EDID Clock Input
7	DATAEDID	EDID Data Input
8	RxOIN0-	-LVDS Differential Data INPUT(Odd R0-R5,G0)
9	RxOIN0+	+LVDS Differential Data INPUT(Odd R0-R5,G0)
10	VSS	Ground
11	RxOIN1-	-LVDS Differential Data INPUT(Odd G1-G5,B0-B1)
12	RxOIN1+	+LVDS Differential Data INPUT(Odd G1-G5,B0-B1)
13	VSS	Ground
14	RxOIN2-	-LVDS Differential Data INPUT(Odd B2-B5,HS,VS,DE)
15	RxOIN2+	+LVDS Differential Data INPUT(Odd B2-B5,HS,VS,DE)
16	VSS	Ground
17	RxOCKIN-	-LVDS Odd Differential Clock INPUT
18	RxOCKIN+	+LVDS Odd Differential Clock INPUT
19	VSS	Ground
20	RxEINO-	-LVDS Differential Data INPUT(Even R0-R5,G0)
21	RxEINO-	+LVDS Differential Data INPUT(Even R0-R5,G0)



22	VSS	Ground
23	RxEIN1-	-LVDS Differential Data INPUT(Even G1-G5,B0-B1)
24	RxEIN1+	+LVDS Differential Data INPUT(Even G1-G5,B0-B1)
25	VSS	Ground
26	RxEIN2-	-LVDS Differential Data INPUT(Even B2-B5,HS,VS,DE)
27	RxEIN2+	+LVDS Differential Data INPUT(Even B2-B5,HS,VS,DE)
28	VSS	Ground
29	RxECKIN-	-LVDS Even Differential Clock INPUT
30	RxECKIN+	+LVDS Even Differential Clock INPUT
31	VLED_GND	LED Ground
32	VLED_GND	LED Ground
33	VLED_GND	LED Ground
34	NC	No Connection
35	S_PWMIN	System PWM Logic Input level
36	LED_EN	LED enable input level
37	NC	No Connection
38	VLED	LED Power Supply
39	VLED	LED Power Supply
40	VLED	LED Power Supply



Note1: Input signals shall be low or High-impedance state when VDD is off.



Note1: Input signals shall be low or High-impedance state when VDD is off.



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## **6.4 Interface Timing**

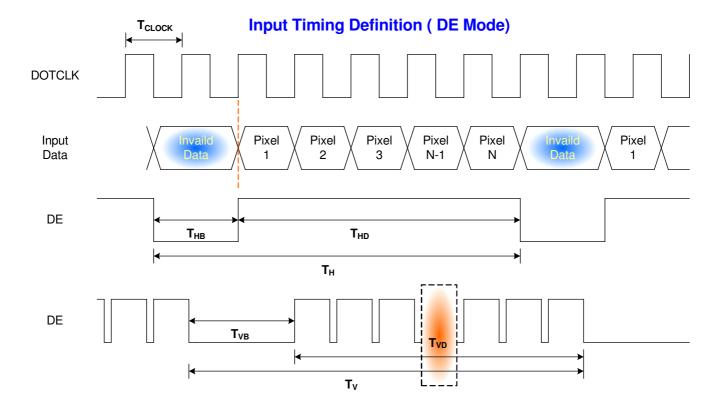
## **6.4.1 Timing Characteristics**

Basically, interface timings should match the 1920X1080 / 60Hz manufacturing guide line timing.

Parar	meter	Symbol	Min.	Тур.	Max.	Unit
Frame	e Rate	-	50	60	-	Hz
Clock fre	equency	1/ T <sub>Clock</sub>	50	74.9	85	MHz
	Period	T <sub>V</sub>	1088	1130	1680	
Vertical	Active	<b>T</b> VD		<b>T</b> Line		
Section	Blanking	T∨B	8	50	-	
	Period	T <sub>H</sub>	990	1050	-	
Horizontal Section	Active	<b>T</b> HD		1920		$T_{Clock}$
	Blanking	<b>T</b> HB	30	90	-	

Note: DE mode only

## 6.4.2 Timing diagram

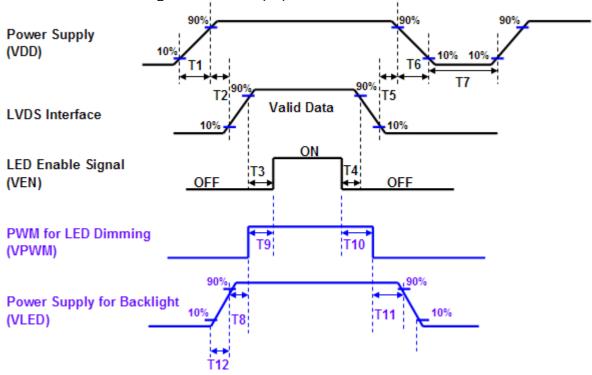




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## 6.5 Power ON/OFF Sequence

Power on/off sequence is as follows. Interface signals and LED on/off sequence are also shown in the chart. Signals from any system shall be Hi-Z state or low level when VDD is off



Power Sequence Timing							
	Val	ue					
Parameter	Min.	Max.	Units				
T1	0.5	10					
T2	0	50					
Т3	200	-					
T4	200	-					
T5	0	50					
T6	0	10	ms				
T7	500	-	1113				
Т8	10	-					
Т9	10	180					
T10	10	180					
T11	10	-					
T12	0.5	10					

Note:If T3,T5,T6 couldn't match above specifications, must request  $\underline{\text{T3+T5+T6}} > \underline{\text{200ms}}$  at least



## 7. Panel Reliability Test

#### 7.1 Vibration Test

**Test Spec:** 

Test method: Non-Operation

Acceleration: 1.5 G

Frequency: 10 - 500Hz Random

30 Minutes each Axis (X, Y, Z) Sweep:

#### 7.2 Shock Test

#### **Test Spec:**

Test method: Non-Operation

Acceleration: 220 G, Half sine wave

Active time: 2 ms

Pulse: X,Y,Z .one time for each side

## 7.3 Reliability Test

Items	Required Condition	Note
Temperature Humidity Bias	Ta= 40℃, 90%RH, 300h	
High Temperature Operation	Ta= 50℃, Dry, 300h	
Low Temperature Operation	Ta= 0℃, 300h	
High Temperature Storage	Ta= 60℃, 35%RH, 300h	
Low Temperature Storage	Ta= -20℃, 50%RH, 250h	
Thermal Shock Test	Ta=-20°C to 60°C, Duration at 30 min, 100 cycles	
ESD	Contact : ±8 KV	Note 1
LSD	Air: ±15 KV	

Note1: According to EN 61000-4-2, ESD class B: Some performance degradation allowed. No data lost . Self-recoverable. No hardware failures.

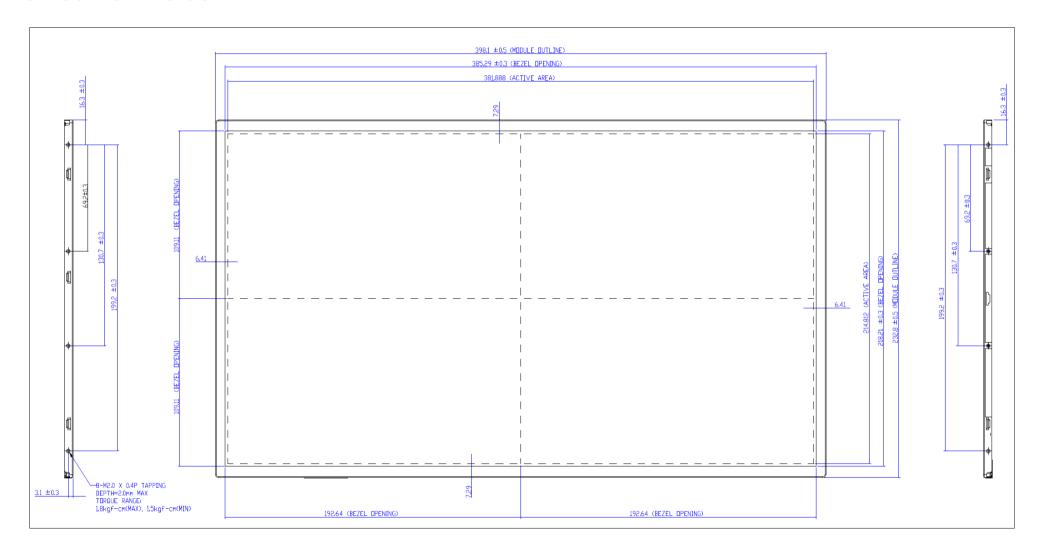
Remark: MTBF (Excluding the LED): 30,000 hours with a confidence level 90%



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## 8. Mechanical Characteristics

### **8.1 LCM Outline Dimension**

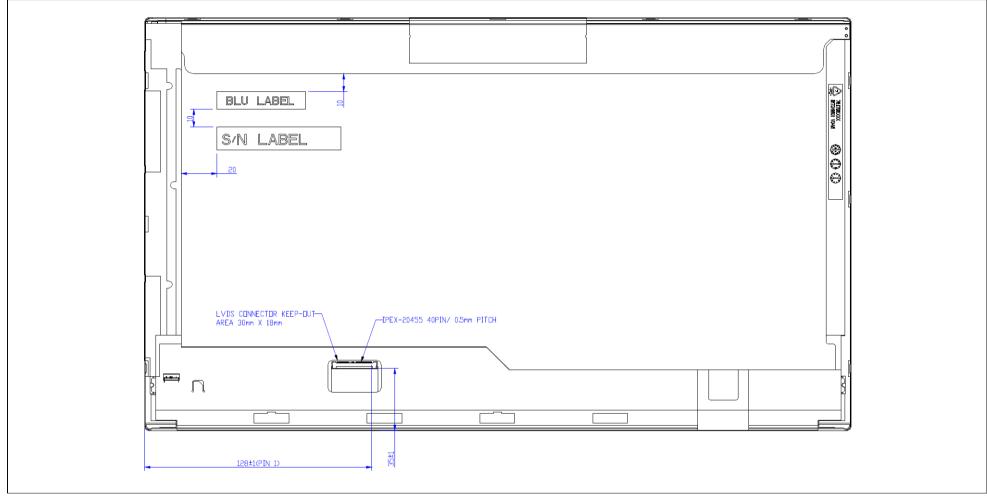


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Note: Prevention IC damage, IC positions not allowed any overlap over these areas.

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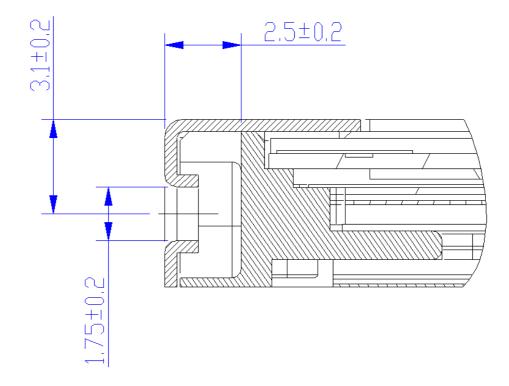


## 8.2 Screw Hole Depth and Center Position

Maximum Screw penetration from side surface is 2.3 mm

The center of screw hole center location is  $3.1 \pm 0.2$ mm from front surface

Screw Torque: Maximum 2.5 kgf-cm





## 9. Shipping and Package

## 9.1 Shipping Label Format



Manufactured YY/WW Model No: B173HW01 V5 **AU Optronics** MADE IN CHINA (S3)

E204356

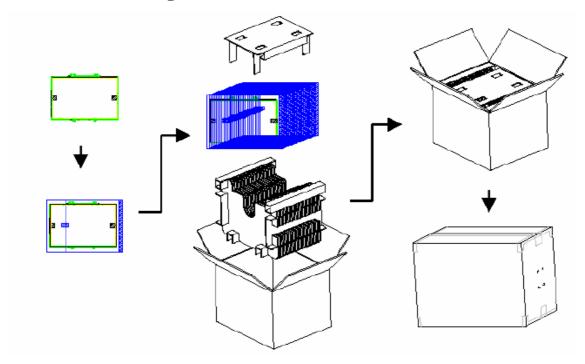


RoHS

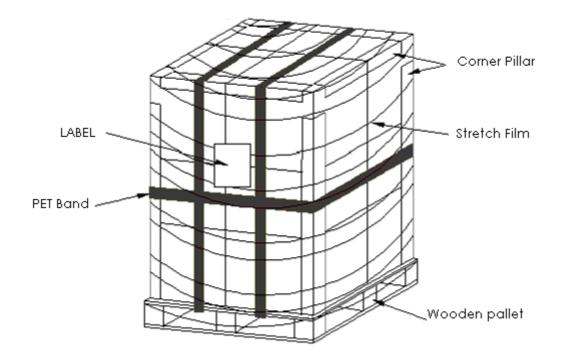
H/W: 0A F/W:1



## 9.2 Carton Package



## 9.3 Shipping Package of Palletizing Sequence





10. Appendix: EDID Description

Address	FUNCTION	Value	Value	Value	Note
0	Header	00	00000000	0	
1		FF	11111111	255	
2		FF	11111111	255	
3		FF	11111111	255	
4		FF	11111111	255	
5		FF	11111111	255	
6		FF	11111111	255	
7		00	00000000	0	
8	EISA Manuf. Code LSB	06	00000110	6	
9	Compressed ASCII	AF	10101111	175	
0A	Product Code	9D	10011101	157	
ОВ	hex, LSB first	15	00010101	21	
0C	32-bit ser #	00	00000000	0	
0D		00	00000000	0	
OE		00	00000000	0	
OF		00	00000000	0	
10	Week of manufacture	01	00000001	1	
11	Year of manufacture	13	00010011	19	
12	EDID Structure Ver.	01	00000001	1	
13	EDID revision #	03	00000011	3	
14	Video input def. (digital I/P, non-TMDS, CRGB)	80	10000000	128	
15	Max H image size (rounded to cm)	26	00100110	38	
16	Max V image size (rounded to cm)	15	00010101	21	
17	Display Gamma (=(gamma*100)-100)	78	01111000	120	
	Feature support (no DPMS, Active OFF, RGB,				
18	tmg Blk#1)	0A	00001010	10	
19	Red/green low bits (Lower 2:2:2:2 bits)	C8	11001000	200	
1A	Blue/white low bits (Lower 2:2:2:2 bits)	95	10010101	149	
1B	Red x (Upper 8 bits)	9E	10011110	158	
1C	Red y/ highER 8 bits	57	01010111	87	
1D	Green x	54	01010100	84	
1E	Green y	92	10010010	146	
1F	Blue x	26	00100110	38	
20	Blue y	OF	00001111	15	
21	White x	50	01010000	80	



22	White y	54	01010100	84	
23	Established timing 1	00	00000000	0	
24	Established timing 2	00	00000000	0	
25	Established timing 3	00	0000000	0	
26	Standard timing #1	01	0000001	1	
27		01	0000001	1	
28	Standard timing #2	01	0000001	1	
29		01	00000001	1	
2A	Standard timing #3	01	0000001	1	
2B		01	0000001	1	
2C	Standard timing #4	01	0000001	1	
2D		01	0000001	1	
2E	Standard timing #5	01	0000001	1	
2F		01	00000001	1	
30	Standard timing #6	01	0000001	1	
31		01	00000001	1	
32	Standard timing #7	01	0000001	1	
33		01	0000001	1	
34	Standard timing #8	01	0000001	1	
35		01	00000001	1	
36	Pixel Clock/10000 LSB	84	10000100	132	
37	Pixel Clock/10000 USB	3A	00111010	58	
38	Horz active Lower 8bits	80	10000000	128	
39	Horz blanking Lower 8bits	E6	11100110	230	
3A	HorzAct:HorzBlnk Upper 4:4 bits	70	01110000	112	
3B	Vertical Active Lower 8bits	38	00111000	56	
3C	Vertical Blanking Lower 8bits	50	01010000	80	
3D	Vert Act : Vertical Blanking (upper 4:4 bit)	40	01000000	64	
3E	HorzSync. Offset	6C	01101100	108	
3F	HorzSync.Width	30	00110000	48	
40	VertSync.Offset : VertSync.Width	AA	10101010	170	
41	Horz‖ Sync Offset/Width Upper 2bits	00	00000000	0	
42	Horizontal Image Size Lower 8bits	7D	01111101	125	
43	Vertical Image Size Lower 8bits	D6	11010110	214	
44	Horizontal & Vertical Image Size (upper 4:4 bits)	10	00010000	16	
45	Horizontal Border (zero for internal LCD)	00	00000000	0	
46	Vertical Border (zero for internal LCD)	00	00000000	0	
	Signal (non-intr, norm, no stero, sep sync, neg				
47	pol)	18	00011000	24	



48	Detailed timing/monitor	00	00000000	0	
49	descriptor #2	00	00000000	0	
4A		00	00000000	0	
4B		OF	00001111	15	
4C		00	00000000	0	
4D		00	00000000	0	
4E		00	00000000	0	
4F		00	00000000	0	
50		00	00000000	0	
51		00	00000000	0	
52		00	00000000	0	
53		00	00000000	0	
54		00	00000000	0	
55		00	00000000	0	
56		00	00000000	0	
57		00	00000000	0	
58		00	00000000	0	
59		20	00100000	32	
5A	Detailed timing/monitor	00	00000000	0	
5B	descriptor #3	00	00000000	0	
5C		00	00000000	0	
5D		FE	11111110	254	
5E		00	00000000	0	
5F	Manufacture	41	01000001	65	Α
60	Manufacture	55	01010101	85	U
61	Manufacture	4F	01001111	79	0
62		0A	00001010	10	
63		20	00100000	32	
64		20	00100000	32	
65		20	00100000	32	
66		20	00100000	32	
67		20	00100000	32	
68		20	00100000	32	
69		20	00100000	32	
6A		20	00100000	32	
6B		20	00100000	32	
6C	Detailed timing/monitor	00	00000000	0	
6D	descriptor #4	00	00000000	0	
6E		00	00000000	0	



[ ,				1	
6F		FE	111111110	254	
70		00	00000000	0	
71	Manufacture P/N	42	01000010	66	В
72	Manufacture P/N	31	00110001	49	1
73	Manufacture P/N	37	00110111	55	7
74	Manufacture P/N	33	00110011	51	3
75	Manufacture P/N	48	01001000	72	Н
76	Manufacture P/N	57	01010111	87	W
77	Manufacture P/N	30	00110000	48	0
78	Manufacture P/N	31	00110001	49	1
79	Manufacture P/N	20	00100000	32	
7A	Manufacture P/N	56	01010110	86	V
7B	Manufacture P/N	35	00110101	53	5
7C		20	00100000	32	
7D		0A	00001010	10	
7E	Extension Flag	00	00000000	0	
7F	Checksum	20	00100000	32	